

$V_{(BR)DSS}$	$R_{DS(on)MAX}$	I_D
-30V	55 mΩ@-10 V	-4.2
	68 mΩ@-4.5V	
	90 mΩ@-2.5V	

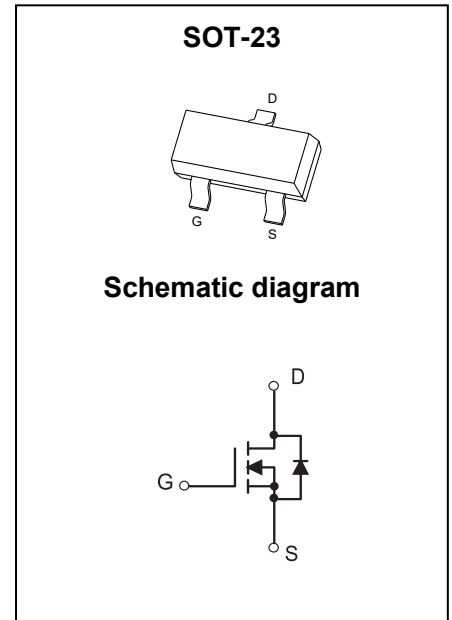
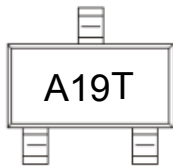
FEATURE

- TrenchFET Power MOSFET

APPLICATION

- Load Switch for Portable Devices
- DC/DC Converter

MARKING



Maximum ratings (T_a=25°C unless otherwise noted)

Parameter	Symbol	Value	Unit
Drain-Source Voltage	V_{DS}	-30	V
Gate-Source Voltage	V_{GS}	±12	
Continuous Drain Current	I_D	-4.2	A
Pulsed Drain Current	I_{DM}	-30	
Maximum Power Dissipation	P_D	0.35	W
Thermal Resistance from Junction to Ambient(t ≤5s)	$R_{θJA}$	357	°C/W
Junction Temperature	T_J	150	°C
Storage Temperature	T_{stg}	-55~+150	

MOSFET ELECTRICAL CHARACTERISTICS
T_a=25 °C unless otherwise specified

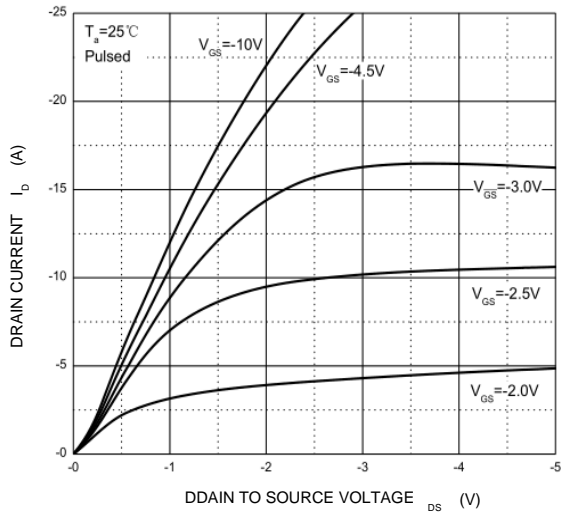
Parameter	Symbol	Test Condition	Min	Typ	Max	Units
Static						
Drain-source breakdown voltage	V _{(BR)DSS}	V _{GS} = 0V, I _D = -250μA	-30	-32.2		V
Gate-source threshold voltage	V _{GS(th)}	V _{DS} = V _{GS} , I _D = -250μA	-0.7	-0.8	-1.3	
Gate-source leakage	I _{GSS}	V _{DS} = 0V, V _{GS} = ±12V			±100	nA
Zero gate voltage drain current	I _{DSS}	V _{DS} = -24V, V _{GS} = 0V			-1	μA
Drain-source on-state resistance ^a	R _{DS(on)}	V _{GS} = -10V, I _D = -4.2A		39	55	mΩ
		V _{GS} = -4.5V, I _D = -4.0A		57	68	
		V _{GS} = -2.5V, I _D = -1.0A		74	90	
Forward transconductance ^a	g _{fs}	V _{DS} = -5V, I _D = -5A		7		S
Dynamic^b						
Input capacitance	C _{iss}	V _{DS} = -15V, V _{GS} = 0V, f = 1MHz		954		pF
Output capacitance	C _{oss}			115		
Reverse transfer capacitance	C _{rss}			77		
Switching characteristics						
Turn-on delay time	t _{d(on)}	V _{GS} = -10V, V _{DS} = -15V R _L = 3.6Ω, R _{GEN} = 6Ω			6.3	ns
Rise time	t _r				3.2	
Turn-off delay time	t _{d(off)}				38.2	
Fall time	t _f				12	
Drain-source body diode characteristics						
Pulse diode forward current ^a	I _{SM}					A
Body diode voltage	V _{SD}	I _S = -1A		-0.8	-1.0	V

Notes :

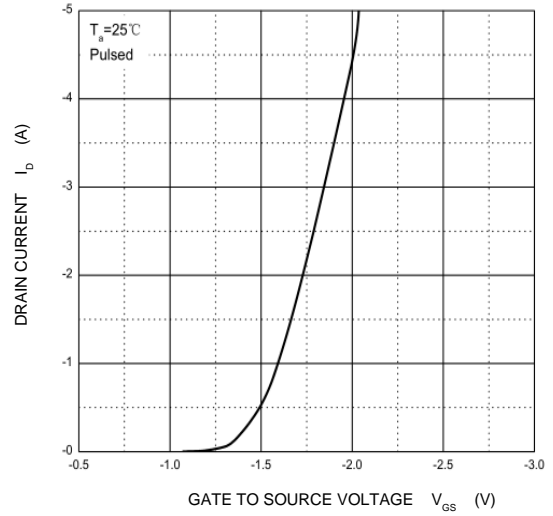
a. Pulse Test : Pulse Width < 300μs, Duty Cycle ≤ 2%.

b. Guaranteed by design, not subject to production testing.

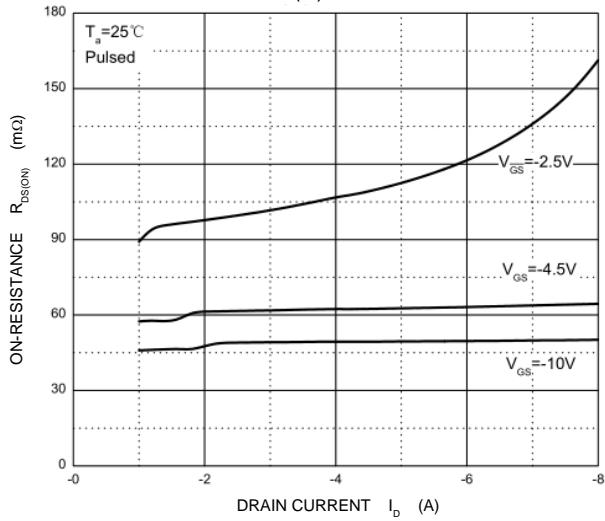
Output Characteristics



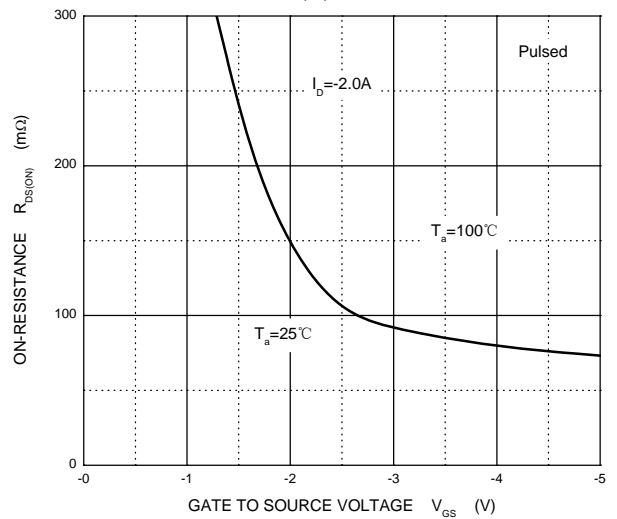
Transfer Characteristics



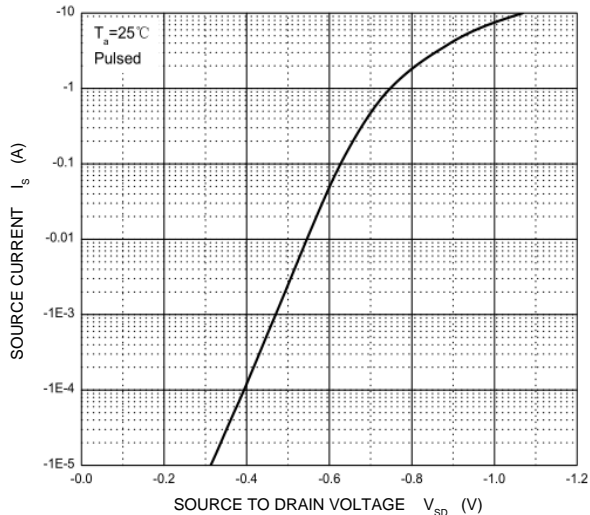
$R_{DS(ON)}$ — I_D



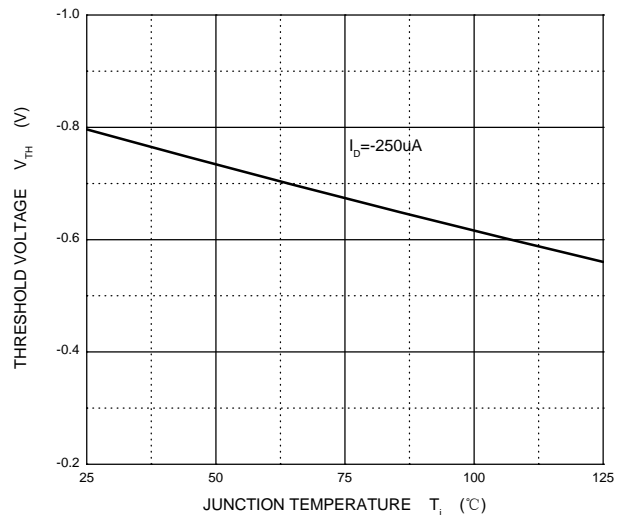
$R_{DS(ON)}$ — V_{GS}

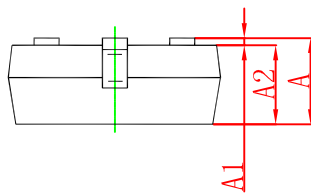
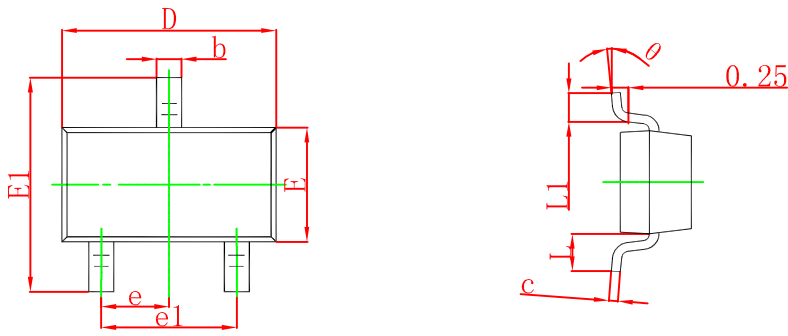


I_S — V_{SD}



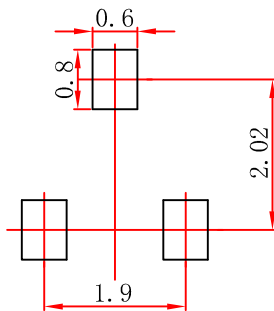
Threshold Voltage





Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min	Max	Min	Max
A	0.900	1.150	0.035	0.045
A1	0.000	0.100	0.000	0.004
A2	0.900	1.050	0.035	0.041
b	0.300	0.500	0.012	0.020
c	0.080	0.150	0.003	0.006
D	2.800	3.000	0.110	0.118
E	1.200	1.400	0.047	0.055
E1	2.250	2.550	0.089	0.100
e	0.950 TYP		0.037 TYP	
e1	1.800	2.000	0.071	0.079
L	0.550 REF		0.022 REF	
L1	0.300	0.500	0.012	0.020
θ	0°	8°	0°	8°

SOT-23 Suggested Pad Layout



- Note:
1. Controlling dimension: in millimeters.
 2. General tolerance: ± 0.05 mm.
 3. The pad layout is for reference purposes only.